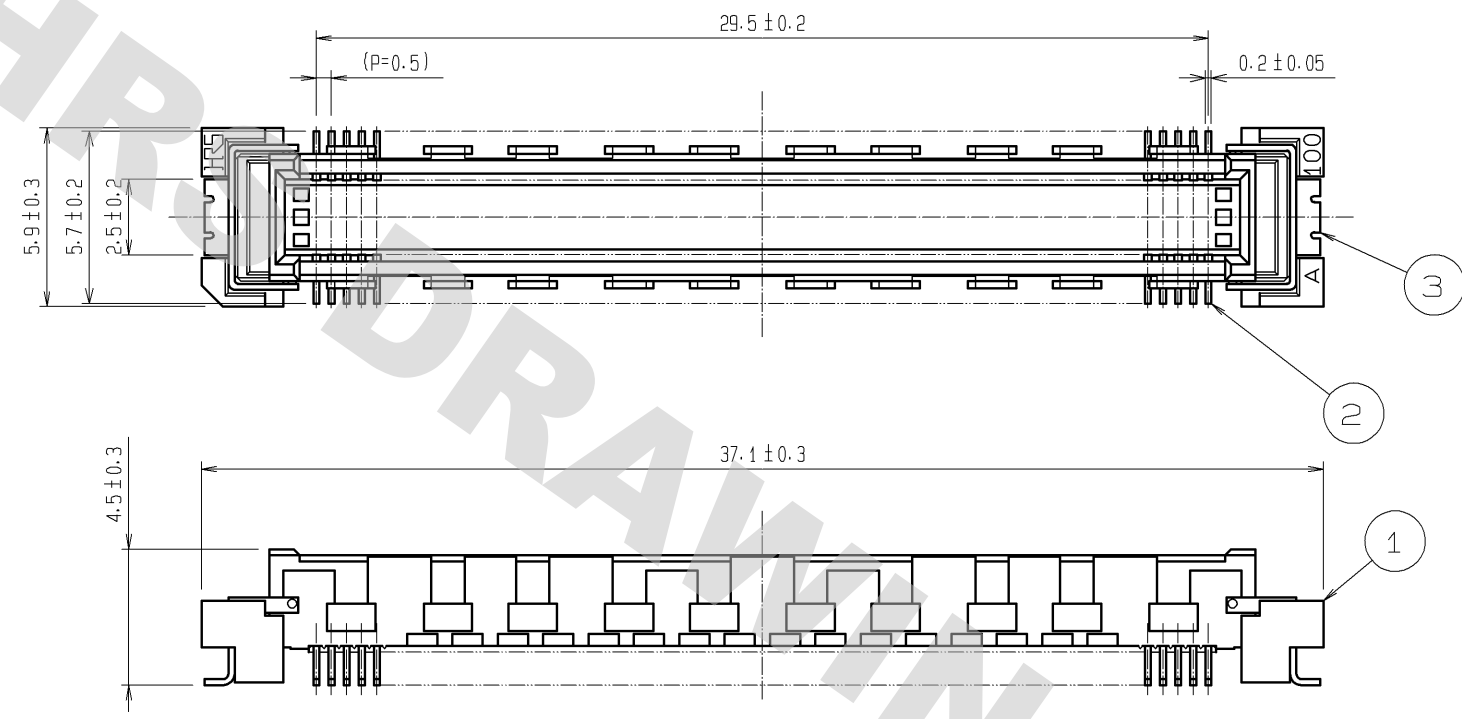
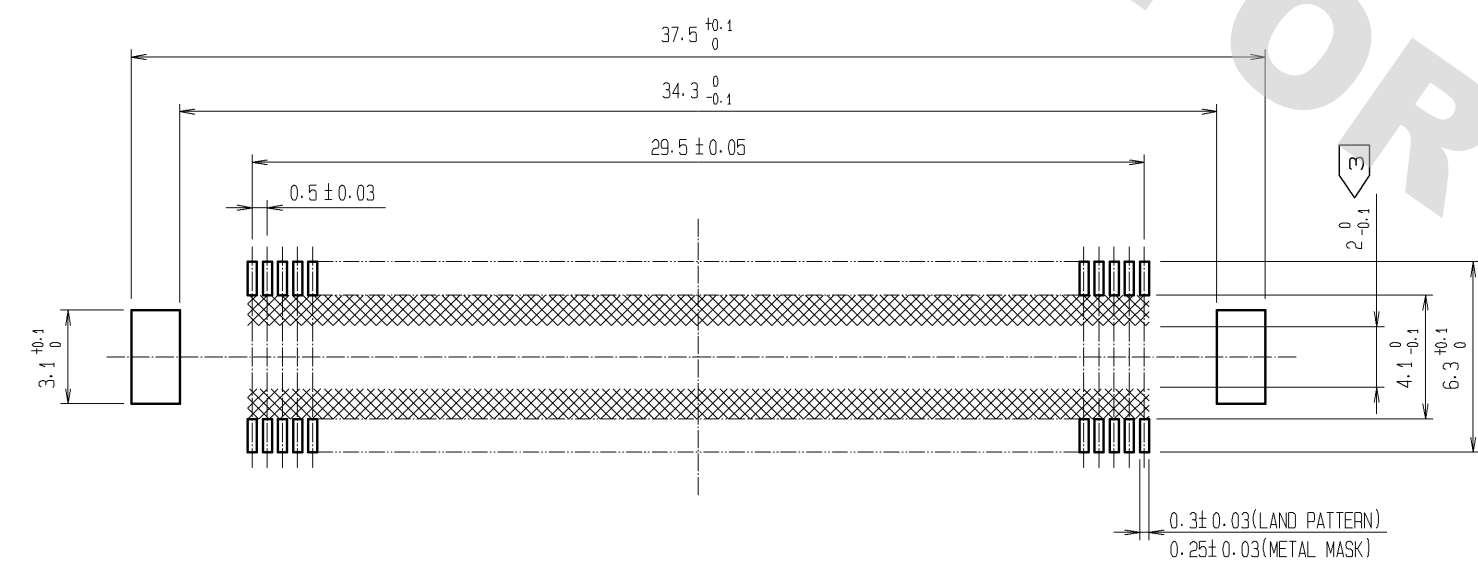


DRAWING FOR REFERENCE: This is subject to change without notice
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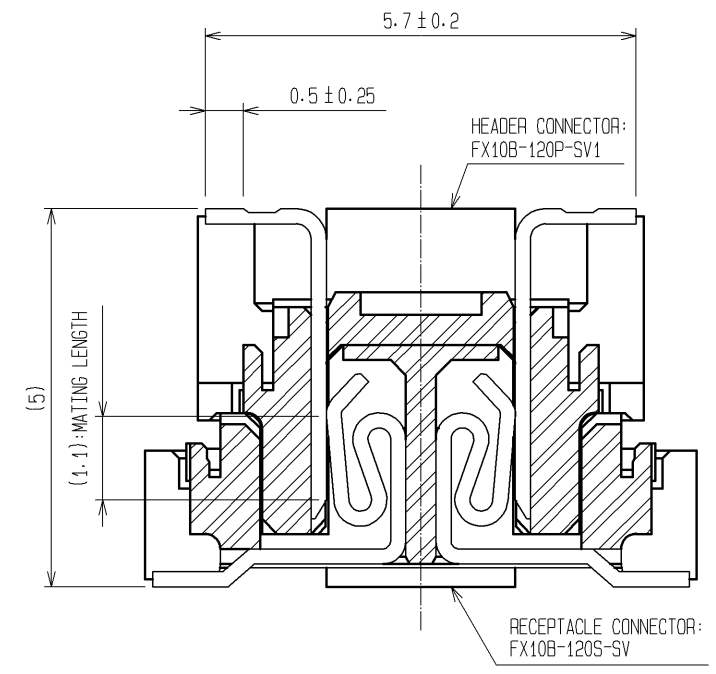
- NOTES
- 1 SMT LEAD-COPLANARITY:0.1 MAX.
 - 2 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ③ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - 4 EMBOSS CARRIER TAPE PACKAGE IS APPLIED ON THIS PRODUCT. PLEASE REFER TO THE SHEET 2/2 FOR THE DETAILS.
 - 5 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.



RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS:0.15mm)



CROSS CUT SECTION (10:1)



3	PHOSPHOR BRONZE	TIN-PLATING							
2	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1μm min.							
		LEAD AREA :TIN-PLATING 1μm min.							
		UNDER PLATING : NICKEL 1μm min.	5	POLYESTER	TOP COVER TAPE				
1	LCP	BEIGE UL94V-0	4	POLYSTYRENE	EMBOSSED CARRIER TAPE				
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS				
UNITS mm		SCALE 4 : 1	COUNT 	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE	
HIROSE ELECTRIC CO., LTD.		APPROVED : HT. YAMAGUCHI	10.07.29	DRAWING NO.	EDC3-151973-21				
		CHECKED : HT. YAMAGUCHI	10.07.29	PART NO.	FX10B-120P-SV1(91)				
		DESIGNED : SY. KAMIGA	10.07.29	CODE NO.	CL570-0152-0-91				
		DRAWN : HK. SUNADORI	10.07.28						1/2

DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

